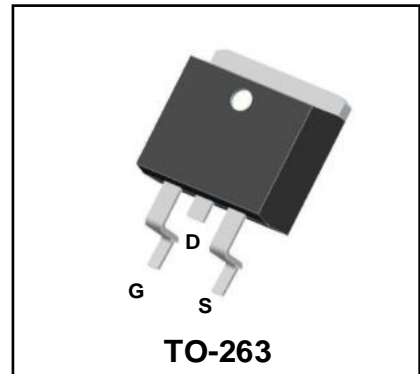


150V N-Channel Enhancement Mode Power MOSFET

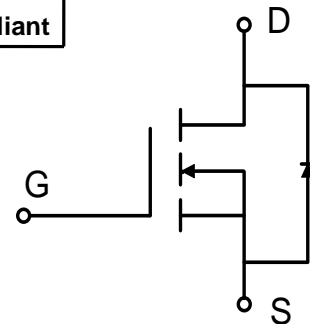
Description

WMM161N15T2 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.



Features

- $V_{DS} = 150V$, $I_D = 161A$
 $R_{DS(on)} < 5.7m\Omega @ V_{GS} = 10V$
- High Speed Power Switching
- Low $R_{DS(ON)}$
- Low Gate Charge
- 100% EAS Guaranteed



Applications

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- UPS

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source voltage		V_{DS}	150	V
Gate-Source voltage		V_{GS}	± 20	V
Continuous Drain Current ¹	$T_C = 25^\circ C$	I_D	161	A
	$T_C = 100^\circ C$		115	
Pulsed Drain Current ²		I_{DM}	540	A
Single Pulse Avalanche Energy ³		EAS	720	mJ
Total Power Dissipation ⁴	$T_C = 25^\circ C$	P_D	360	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 175	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	61	$^\circ C/W$
Thermal Resistance from Junction-to-Case ¹	$R_{\theta JC}$	0.4	$^\circ C/W$

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	150	-	-	V
Gate-body Leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA
Zero Gate Voltage Drain Current	$T_J = 25^\circ\text{C}$	I_{DSS} $V_{DS} = 150V, V_{GS} = 0V$	-	-	1	μA
	$T_J = 100^\circ\text{C}$		-	-	100	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	4	V
Drain-Source On-Resistance ²	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	-	5.2	5.7	m Ω
Transconductance	g_{fs}	$V_{DS} = 5V, I_D = 20A$	-	80	-	S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 75V, V_{GS} = 0V,$ $f = 1\text{MHz}$	-	6220	-	pF
Output Capacitance	C_{oss}		-	480	-	
Reverse Transfer Capacitance	C_{rss}		-	11	-	
Switching Characteristics						
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS}$ Open, $f = 1\text{MHz}$	-	2.7	-	Ω
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DD} = 75V,$ $I_D = 20A$	-	78	-	nC
Gate-Source Charge	Q_{gs}		-	29	-	
Gate-Drain Charge	Q_{gd}		-	11	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 75V,$ $R_G = 10\Omega, I_D = 20A$	-	26	-	nS
Rise Time	t_r		-	19	-	
Turn-Off Delay Time	$t_{d(off)}$		-	39	-	
Fall Time	t_f		-	15	-	
Drain-source body diode Characteristics						
Diode Forward Voltage ²	V_{SD}	$I_S = 20A, V_{GS} = 0V$	-	0.9	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	$V_R = 75V, I_F = 20A,$ $di/dt = 100A/\mu s$	-	80	-	nS
Body Diode Reverse Recovery Charge	Q_{rr}		-	160	-	nC

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{DD} = 25V, V_{GS} = 10V, L = 0.4\text{mH}, I_{AS} = 60A$
4. The power dissipation is limited by 175°C junction temperature

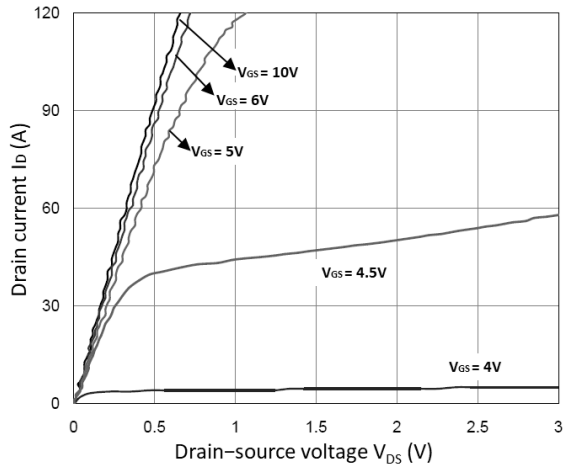


Figure 1. Output Characteristics

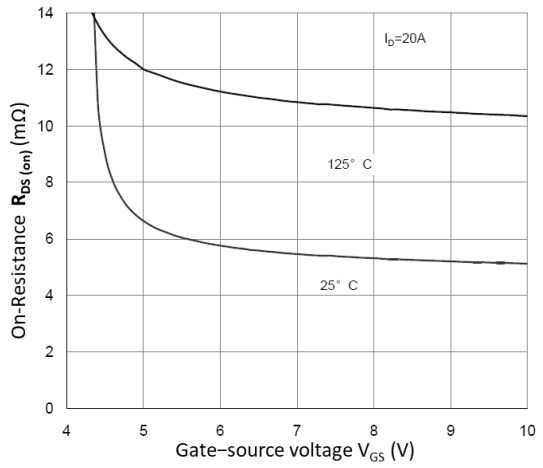


Figure 2. $R_{DS(on)}$ vs. V_{GS}

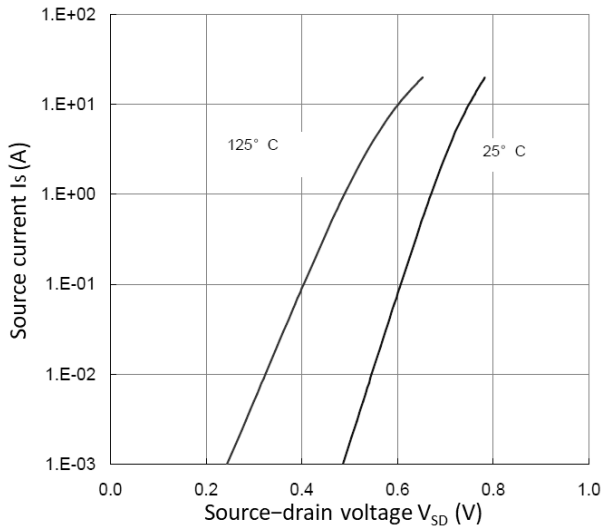


Figure 3. Forward Characteristics of Reverse

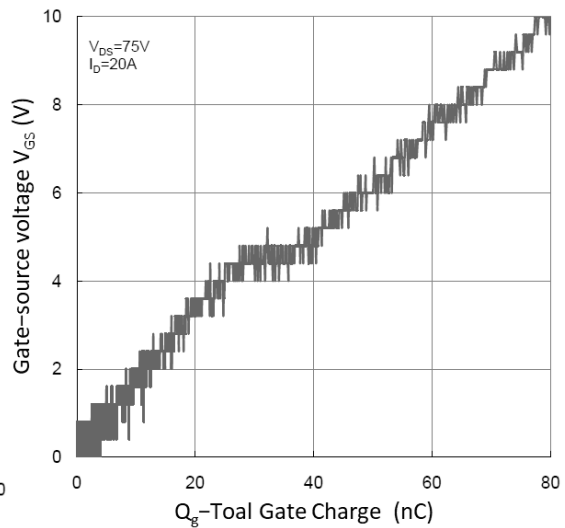


Figure 4. Gate Charge Characteristics

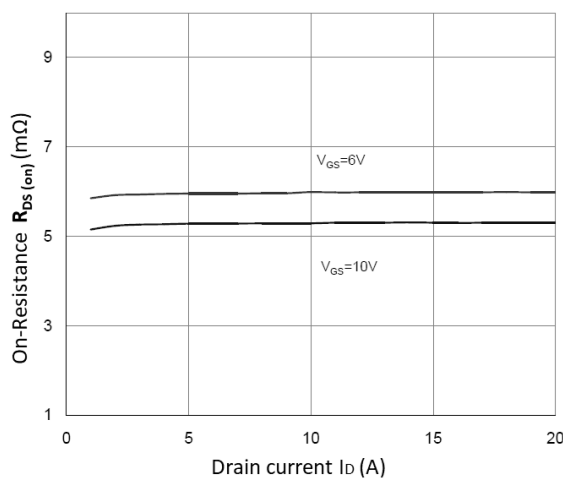


Figure 5. $R_{DS(on)}$ vs. I_D

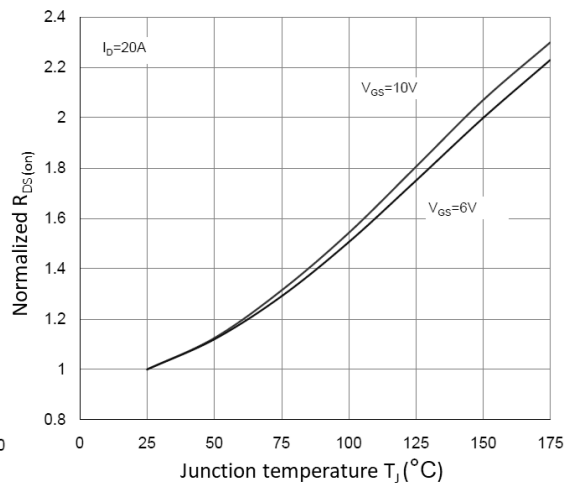


Figure 6. Normalized $R_{DS(on)}$ vs. T_J

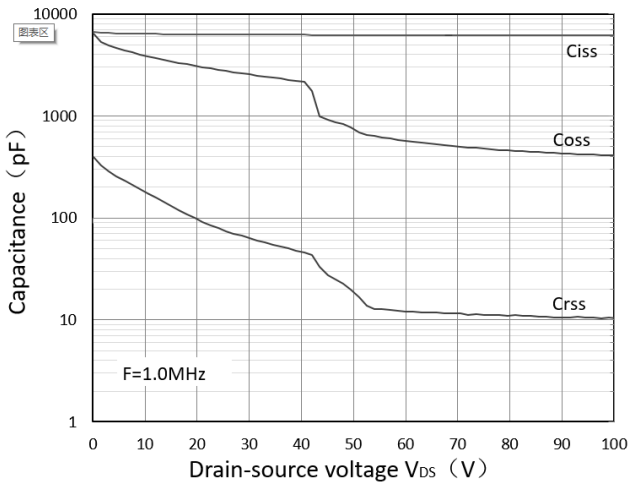


Figure 7. Capacitance Characteristics

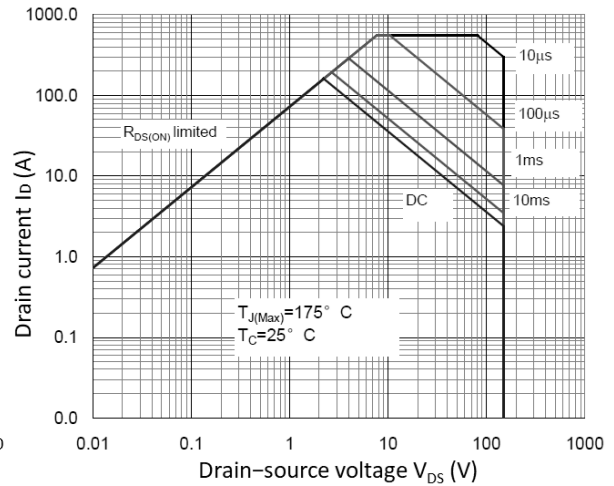


Figure 8. Safe Operating Area

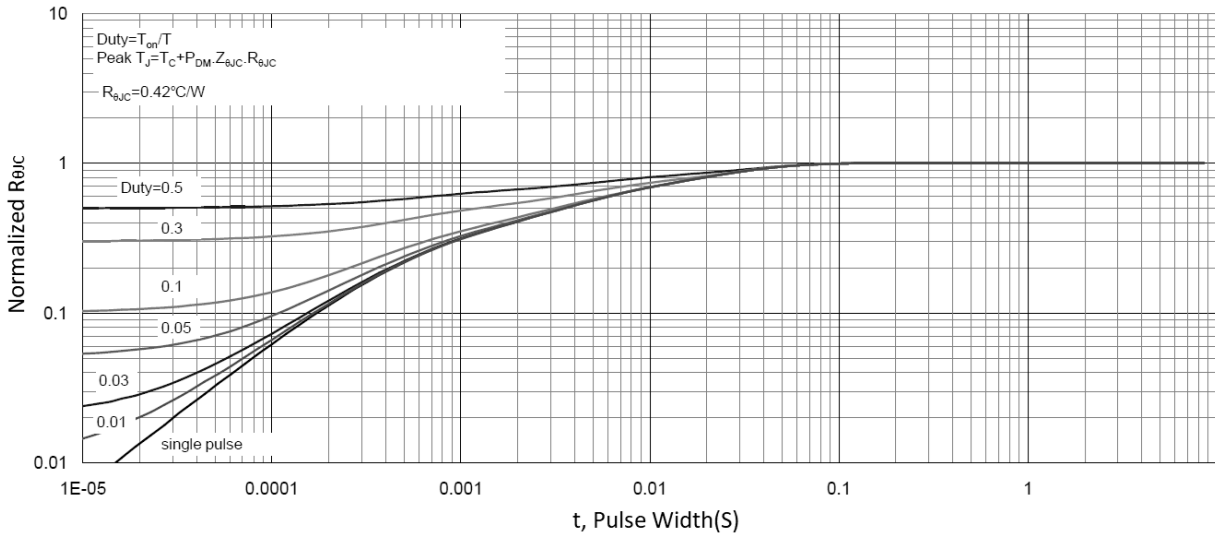


Figure 9. Normalized Maximum Transient Thermal Impedance

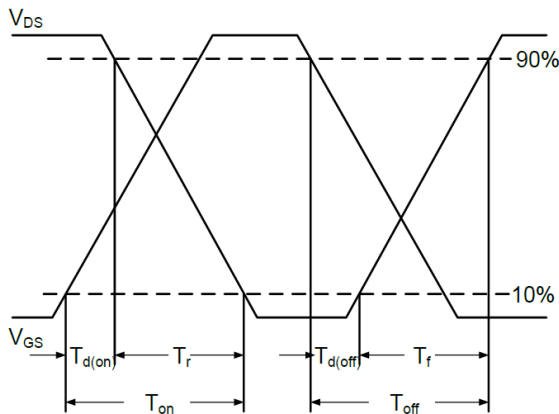


Figure 10. Switching Time Waveform

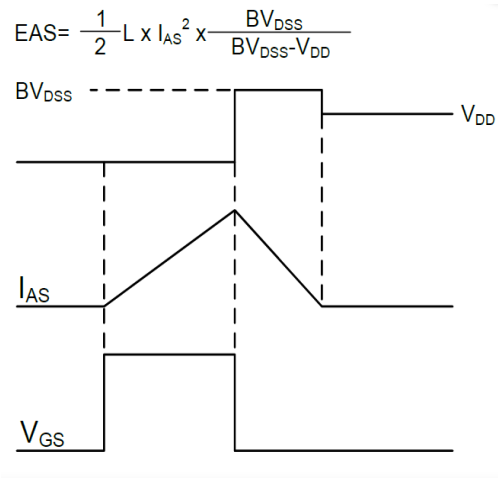
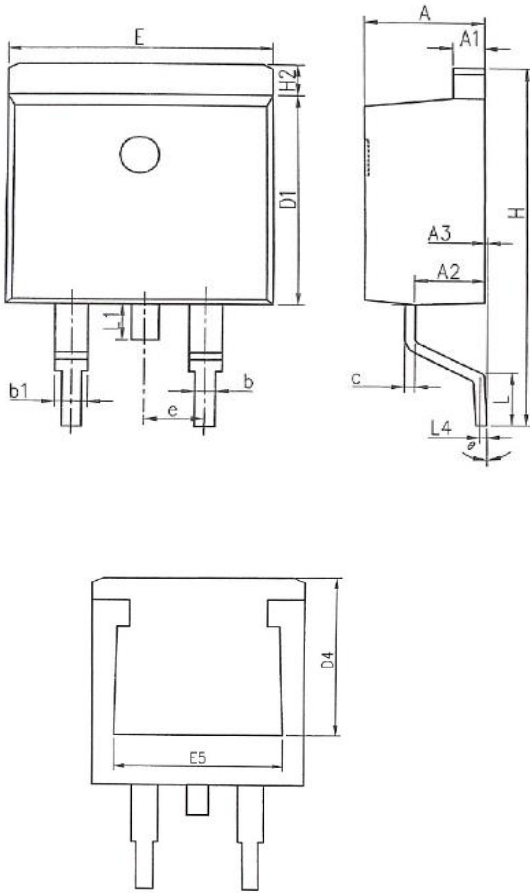


Figure 11. Unclamped Inductive Switching Waveform

Mechanical Dimensions for TO-263

COMMON DIMENSIONS

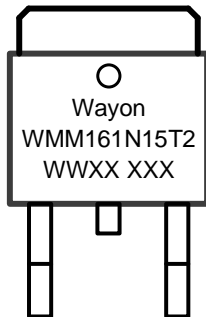


SYMBOL	MM	
	MIN	MAX
A	4.064	4.826
A1	1.143	1.651
A2	2.49	2.89
A3	0.00	0.254
b	0.508	0.991
b1	1.143	1.778
c	0.381	0.737
D1	8.382	9.652
D4	6.858	-
E	9.652	10.668
E5	6.223	-
e	2.540BSC	
H	14.605	15.875
H2	-	1.676
L	1.778	2.794
L1	-	1.778
L4	0.254BSC	
θ	0°	8°

Ordering Information

Part	Package	Marking	Packing method
WMM161N15T2	TO-263	WMM161N15T2	Tape and Reel

Marking Information



WMM161N15T2= Device code
 WWXX XXX= Date code

Contact Information

No.1001, Shiwan(7) Road, Pudong District, Shanghai, P.R.China.201207

Tel: 86-21-50310888 Fax: 86-21-50757680 Email: market@way-on.com

WAYON website: <http://www.way-on.com>

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